Product data sheet

1. General description

2x30A, 300V Dual ultrafast power diode in a SOT1259 (3-lead TO-3P) plastic package.

2. Features and benefits

- · Low forward voltage drop
- Fast Switching
- · Soft recovery characteristics
- High thermal cycling performance
- Low thermal resistance

3. Applications

- Telecom power supplies
- · Welding machines
- Secondary rectification in SMPS

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _R	reverse voltage	DC	-	-	300	V
I _{F(AV)}	average forward current	δ = 0.5 ; T _{mb} ≤ 105 °C; square-wave pulse; Fig. 1; Fig. 2; Fig. 3	-	-	30	A
I _{FSM}	non-repetitive peak forward current	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; per diode; Fig. 4	-	-	300	A
		t_p = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; per diode	-	-	330	Α
Static characte	eristics					
V_{F}	forward voltage	I _F = 30 A; T _j = 25 °C; <u>Fig. 6</u>	-	1	1.25	V
		I _F = 30 A; T _j = 150 °C; <u>Fig. 6</u>	-	0.85	1	V
Dynamic chara	acteristics					
t _{rr}	reverse recovery time	$I_F = 1 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 50 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 7$	-	-	55	ns

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	A1	anode 1		A1
2	K	cathode	10 O od	A1 [2] A2
3	A2	anode 2		K sym125
mb	mb	mounting base; connected to cathode	TO3P (SOT1259)	

6. Ordering information

Table 3. Ordering information

Type number	Package			
	Name	Description	Version	
BYV430K-300P	ТОЗР	Plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO3P	SOT1259	

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7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{RRM}	repetitive peak reverse voltage		-	300	V
V_{RWM}	crest working reverse voltage		-	300	V
V_R	reverse voltage	DC	-	300	V
I _{F(AV)}	average forward current	δ = 0.5 ; T _{mb} ≤ 105 °C; square-wave pulse; Fig. 1; Fig. 2; Fig. 3	-	30	Α
I _{O(AV)}	average output current	δ = 0.5 ; T _{mb} ≤ 105 °C; square-wave pulse; both diodes conducting	-	60	Α
I _{FRM}	repetitive peak forward current	δ = 0.5 ; t_p = 25 μ s; $T_{mb} \le 105$ °C; square-wave pulse	-	60	А
I _{FSM}	non-repetitive peak forward current	t _p = 10 ms; T _{j(init)} = 25 °C; sine-wave pulse; per diode; <u>Fig. 4</u>	-	300	А
		t_p = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; per diode	-	330	Α
T _{stg}	storage temperature		-55	175	°C
T _j	junction temperature		-	175	°C
V_{ESD}	electrostatic discharge voltage		-	-	

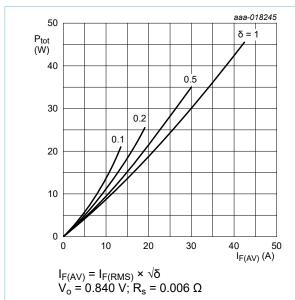


Fig. 1. Forward power dissipation as a function of average forward current; square waveform; per diode; maximum values

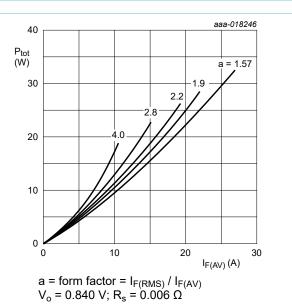


Fig. 2. Forward power dissipation as a function of average forward current; sinusoidal waveform; per diode; maximum values

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Dual ultrafast power diode

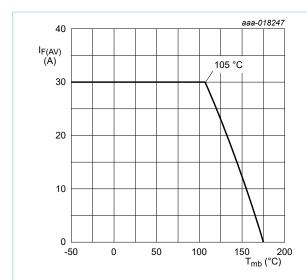


Fig. 3. Average forward current as a function of mounting base temperature; per diode; maximum values

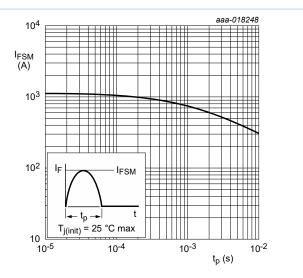


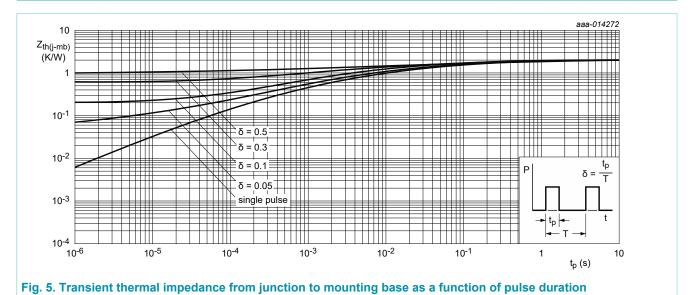
Fig. 4. Non-repetitive peak forward current as a function of pulse width; sinusoidal waveform; per diode; maximum values

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8. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	with heatsink compound; per diode; Fig. 5	-	0.8	2	K/W
		with heatsink compound; both diodes conducting	-	-	1.2	K/W
R _{th(j-a)}	thermal resistance from junction to ambient free air	in free air	-	45	-	K/W



9. Characteristics

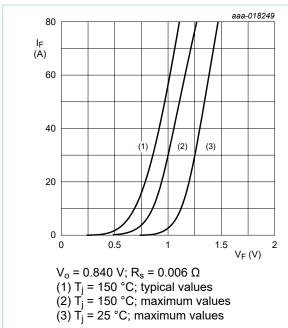
Table 6. Characteristics

characteristics are per diode unless otherwise stated

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	acteristics		,	,		
V _F	forward voltage	I _F = 30 A; T _j = 25 °C; <u>Fig. 6</u>	-	1	1.25	V
		I _F = 30 A; T _j = 150 °C; <u>Fig. 6</u>	-	0.85	1	V
I _R	reverse current	V _R = 300 V; T _j = 25 °C	-	0.4	10	μΑ
		V _R = 300 V; T _j = 150 °C	-	-	500	μΑ
Dynamic ch	naracteristics					
t _{rr}	reverse recovery time	$I_F = 1 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 50 \text{ A/}\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 7$	-	-	55	ns
		$I_F = 30 \text{ A}; V_R = 200 \text{ V}; dI_F/dt = 200 \text{ A}/$ μ s; $T_j = 25 ^{\circ}\text{C}; Fig. 7$	-	33	-	ns
		$I_F = 30 \text{ A}; V_R = 200 \text{ V}; dI_F/dt = 200 \text{ A}/$ μ s; $T_j = 125 ^{\circ}\text{C}; Fig. 7$	-	62	-	ns
I _{RM}	peak reverse recovery current	$I_F = 30 \text{ A}; V_R = 200 \text{ V}; dI_F/dt = 200 \text{ A}/$ μ s; $T_j = 25 ^{\circ}\text{C}; Fig. 7$	-	5.3	-	Α
		$I_F = 30 \text{ A}; V_R = 200 \text{ V}; dI_F/dt = 200 \text{ A}/$ μ s; $T_j = 125 ^{\circ}\text{C}; Fig. 7$	-	10.5	-	Α
Q _r	recovered charge	$I_F = 30 \text{ A}; V_R = 200 \text{ V}; dI_F/dt = 200 \text{ A}/$ μ s; $T_j = 25 ^{\circ}\text{C}; Fig. 7$	-	89	-	nC
		$I_F = 30 \text{ A}; V_R = 200 \text{ V}; dI_F/dt = 200 \text{ A}/$ μ s; $T_j = 125 ^{\circ}\text{C}; Fig. 7$	-	337	-	nC
V_{FR}	forward recovery voltage		-	-	-	

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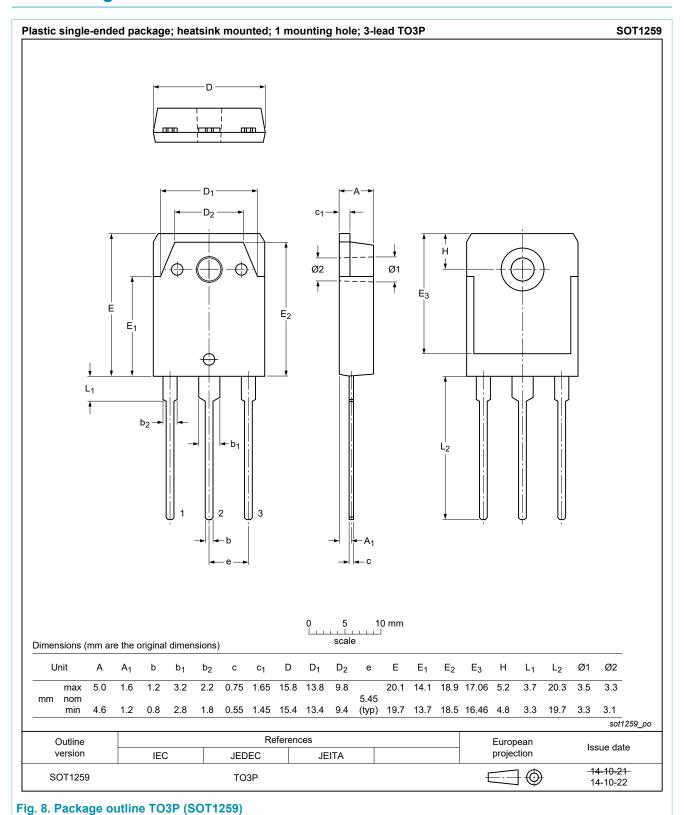
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 $I_{R} \qquad \qquad \frac{dI_{F}}{dt} \qquad \qquad \frac{t_{rr}}{t_{rr}} \qquad \qquad \frac{t_{ime}}{t_{RM}} \qquad \qquad \frac{25 \, \%}{t_{RM}} \qquad \qquad \frac{100 \, \%}{t_{RM}} \qquad \qquad \frac{t_{RM}}{t_{RM}} \qquad \frac{t_{RM}}{t_{RM}}$

Fig. 7. Reverse recovery definitions; ramp recovery

10. Package outline



11. Legal information

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Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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